

## Power line chokes

Current-compensated ring core double chokes

600 V AC / 1000 V DC, 0.42 ... 3.3 mH, 20 ... 50 A, +70 °C


**Series/Type:**            **B8272\*E6**

**Date:**                    October 2024

**Current-compensated ring core double chokes**
**Rated voltage 600 V AC / 1000 V DC**
**Rated inductance 0.42 ... 3.3 mH**
**Rated current 20 ... 50 A / +70 °C**
**Construction**

- Current-compensated ring core double choke
- Ferrite core
- Plastic core case incl. spacer (UL 94 V-0, CTI600)
- Plastic base plate (UL 94 V-0)
- Sector winding
- Clearance and creepage distances  $\geq 8$  mm

**Features**

- Insulation for high voltage applications
- Approx. 0.6 ... 0.8% stray inductance for symmetrical interference suppression
- Wide range of values due to 3 core sizes
- High rated current and rated temperature
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2)
- UL 1446 class 155 (F) electrical insulation system 
- Recyclable owing to omission of adhesives
- RoHS-compatible

**Applications**

- Suppression of common-mode interferences
- High-voltage switch-mode power applications
- Power inverters
- Frequency converters

**Terminals**

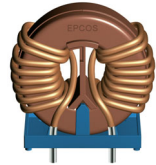
- Ends of winding wires
- Hot-dip tinned

**Marking**

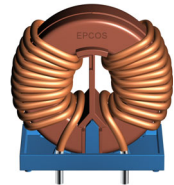
Product brand, electrical insulation system designation, ordering code, rated voltages, rated inductance, rated current, date of manufacture (YYWWD.internal ID code), production place identification code

**Delivery mode**

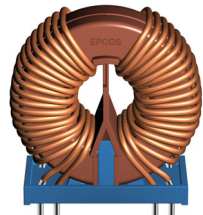
- Cardboard box



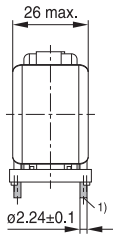
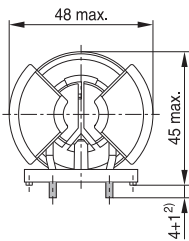
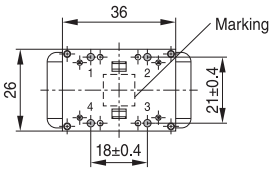
Size A



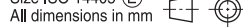
Size B



Size C

**Dimensional drawings and pin configurations**  
**Size A**


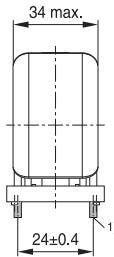
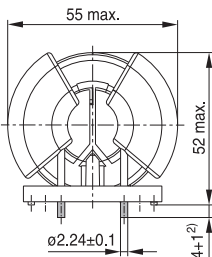
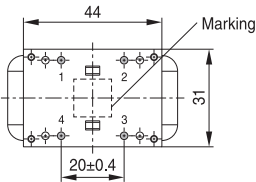
IND2379-G-E

 Tolerances to ISO 2768-c / ISO 8015.  
 Size ISO 14405 (E)


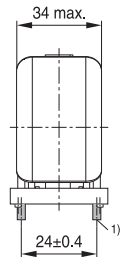
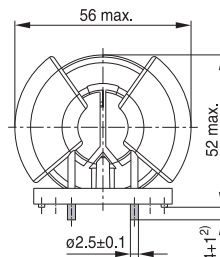
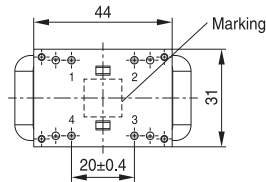
IND2200-F-E

1) Tin tips permissible

2) Dimension does not include tin tip

**Size B**
**Version 1**


IND2383-E-E

**Version 2**


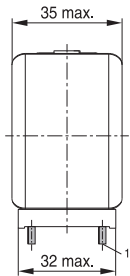
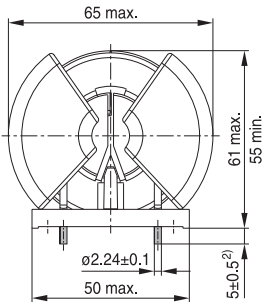
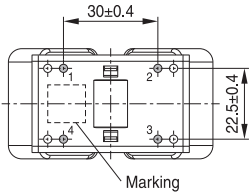
IND2384-R-E

1) Tin tips permissible

2) Dimension does not include tin tip

1) Tin tips permissible

2) Dimension does not include tin tip

**Size C**
**Version 1**


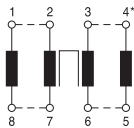
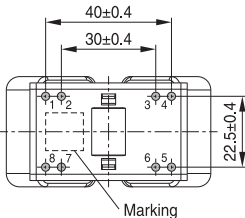
Tolerances to ISO 2768-c / ISO 8015.  
Size ISO 14405 (E)  
All dimensions in mm



- 1) Tin tips permissible
- 2) Dimension does not include tin tip

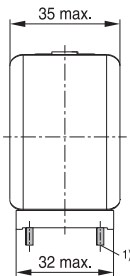
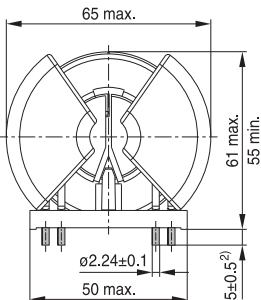
IND2385-T-E

IND2200-F-E

**Version 2**


\*) Parallel wires must be shorted in application!

IND1160-B-E



- 1) Tin tips permissible
- 2) Dimension does not include tin tip

IND2386-3-E

**Technical data and measuring conditions**

Rated voltage $V_R$	600 V AC (50 / 60 Hz) 1000 V DC
Test voltage $V_{\text{test}}$	3500 V DC, 2 s (line/line) 500 V DC, 1 s (parallel wires)
Rated temperature $T_R$	+70 °C
Rated current $I_R$	Referred to 50 Hz and rated temperature (shorted parallel wires in application)
Rated inductance $L_R$	Measured with Agilent 4284A at 0.1 mA, +20 °C Measuring frequency: $L_R \leq 1$ mH: $f = 100$ kHz $L_R > 1$ mH: $f = 10$ kHz Inductance is specified per winding
Inductance tolerance	-30/+50% at +20 °C
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with $I_R$ , +20 °C
Stray inductance $L_{\text{stray,typ}}$	Measured with Agilent 4284A at 5 mA, +20 °C, typical values Measuring frequency: $L_R \leq 1$ mH: $f = 100$ kHz $L_R > 1$ mH: $f = 10$ kHz
DC resistance $R_{\text{typ}}$	Measured at +20 °C, typical values, specified per winding and shorted parallel wires
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +(245 ± 5) °C, (3 ± 0.3) s Wetting of soldering area ≥ 95% (to IEC 60068-2-20, test Ta)
Resistance to soldering heat (wave soldering)	+(260 ± 5) °C, (10 ± 1) s (to IEC 60068-2-20, test Tb)
Climatic category	40/125/56 (to IEC 60068-1)
Pollution degree	P2 (to IEC 61558-1)
Storage conditions (packaged)	-25 °C ... +40 °C, ≤ 75% RH
Approvals	UL1446 Class 155 (F) (E320370)

**Characteristics and ordering codes**
**Size A**

$I_{R,+70\text{ °C}}$ A	$L_R$ mH	$L_{\text{stray,typ}}$ $\mu\text{H}$	$R_{\text{typ}}$ m $\Omega$	Weight approx. g	Ordering code
21	1.5	8.3	2.8	100	B82726E6213A040
24	1.0	5.7	2.3	90	B82726E6243A041
26	0.6	3.8	1.7	85	B82726E6263A040
29	0.44	2.9	1.5	80	B82726S6243A040 <sup>1)</sup>

1) Alternative rating: 24 A at +85 °C

**Size B**

$I_{R,+70\text{ °C}}$ A	$L_R$ mH	$L_{\text{stray,typ}}$ $\mu\text{H}$	$R_{\text{typ}}$ m $\Omega$	Weight approx. g	Ordering code	Version	
						1	2
20	2.7	19	4.4	155	B82726E6203B041	X	—
24	1.5	11	3.2	135	B82726S6203A040 <sup>1)</sup>	X	—
28	1.0	7	2.1	140	B82726E6283B040	—	X
33	0.42	3.5	1.4	120	B82726E6333B040	—	X

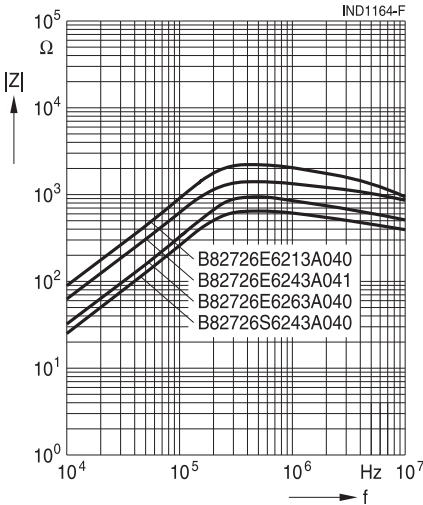
1) Alternative rating: 20 A at +85 °C

**Size C**

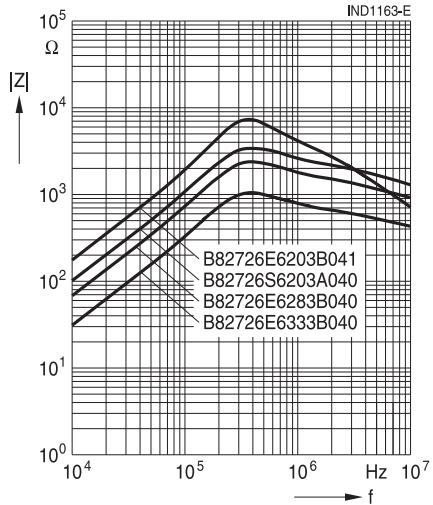
$I_{R,+70\text{ °C}}$ A	$L_R$ mH	$L_{\text{stray,typ}}$ $\mu\text{H}$	$R_{\text{typ}}$ m $\Omega$	Weight approx. g	Ordering code	Version	
						1	2
22	3.3	20.0	4.6	210	B82727E6223A040	X	—
24	2.2	15.0	3.9	200	B82727E6243A040	X	—
40	1.5	9.0	1.7	245	B82727E6403A040	—	X
44	1.0	6.3	1.35	220	B82727E6443A040	—	X
50	0.57	3.7	1.0	200	B82727E6503A040	—	X

Current-compensated ring core double chokes

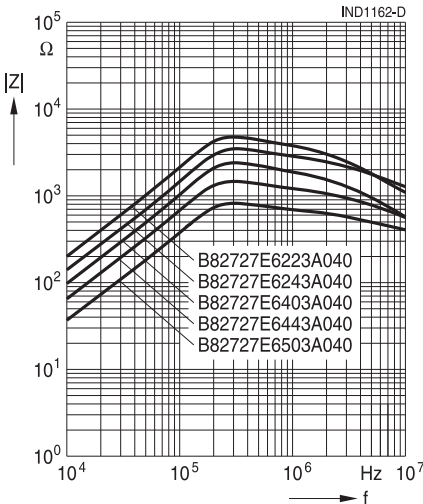
**Impedance  $|Z|$  versus frequency  $f$**   
measured with windings in parallel at +20 °C,  
typical values



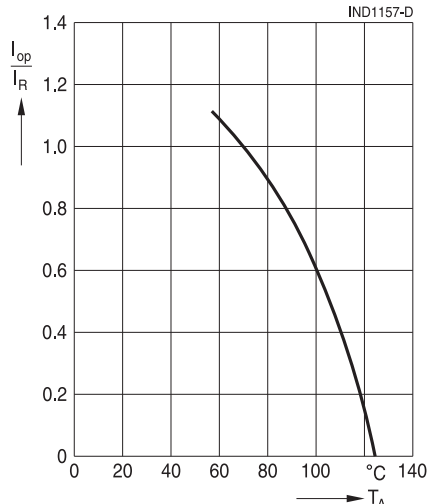
**Impedance  $|Z|$  versus frequency  $f$**   
measured with windings in parallel at +20 °C,  
typical values



**Impedance  $|Z|$  versus frequency  $f$**   
measured with windings in parallel at +20 °C,  
typical values



**Current derating  $I_{op}/I_R$**   
**versus ambient temperature  $T_A$**   
rated temperature  $TR = +70$  °C



### Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
  - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
  - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
 

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
  - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
  - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
  - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
  - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
  - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

Release 2024-08-08

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2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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